



20V P-Channel Trench Power MOSFET

General Description

The SJM20P065 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as -2.5V. This device is suitable for use as a wide variety of applications.

Features

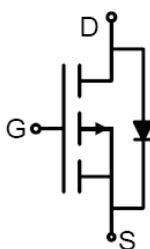
- Low Gate Charge
- High Power and current handling capability
- Lead free product is acquired

Application

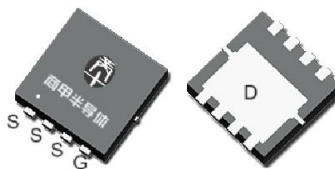
- PWM Applications
- Load Switch
- Power Management

Key Performance Parameters

Parameter	Value	Unit
V_{DS}	-20	V
$R_{DS(ON_TYP)}$	7.9	mΩ
I_D	-50	A
Q_G	52	nC



Schematic Diagram



PDFN3X3-8L top&bottom view



Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJM20P065	SJM20P065	PDFN3X3-8L	Tape	\	\	5000 Pcs

Table 1. Absolute Maximum Ratings ($T_C=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V_{DS}	Drain-Source Voltage ($V_{GS}=0\text{V}$)	-20	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0\text{V}$)	± 12	V
I_D	Drain Current-Continuous($T_C=25^{\circ}\text{C}$)	-50	A
	Drain Current-Continuous($T_C=100^{\circ}\text{C}$)	-32	A
$I_{DM}(\text{pulse})$	Drain Current-Continuous@ Current-Pulsed (Note 1)	-200	A
P_D	Maximum Power Dissipation($T_C=25^{\circ}\text{C}$)	36	W
	Maximum Power Dissipation($T_C=100^{\circ}\text{C}$)	14	W
E_{AS}	Avalanche energy (Note 2)	132	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}\text{C}$

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		3.5	$^{\circ}\text{C/W}$



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Table 3. Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =-250μA	-20			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-20V, V _{GS} =0V T _J =25℃			-1	μA
		V _{DS} =-20V, V _{GS} =0V T _J =125℃			-100	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±12V, V _{DS} =0V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-0.5		-1	V
g _{FS}	Forward Transconductance	V _{DS} =-5V, I _D =-15A		52		S
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =-4.5V, I _D =-15A T _J =25℃		7.9	9.9	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =-2.5V, I _D =-10A T _J =25℃		10	13.3	mΩ
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} =-10V,V _{GS} =0V, f=1.0MHz		3820		pF
C _{oss}	Output Capacitance			358		pF
C _{rss}	Reverse Transfer Capacitance			329		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		5.1		Ω
Switching Parameters						
t _{d(on)}	Turn-on Delay Time	V _{GS} =-4.5V, V _{DS} =-10V, R _L =0.67Ω, R _{GEN} =6Ω		14		nS
t _r	Turn-on Rise Time			7.2		nS
t _{d(off)}	Turn-Off Delay Time			226		nS
t _f	Turn-Off Fall Time			97		nS
Q _g	Total Gate Charge	V _{GS} =-4.5V, V _{DS} =-10V, I _D =-15A		52		nC
Q _{gs}	Gate-Source Charge			9		nC
Q _{gd}	Gate-Drain Charge			14		nC
Source-Drain Diode Characteristics						
I _{SD}	Source-Drain Current (Body Diode)				-50	A
V _{SD}	Forward on Voltage (Note 3)	V _{GS} =0V, I _S =-15A			-1.2	V
t _{rr}	Reverse Recovery Time	I _F =-15A, dI/dt=-100A/μs		24.7		ns
Q _{rr}	Reverse Recovery Charge	I _F =-15A, dI/dt=-100A/μs		11.1		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

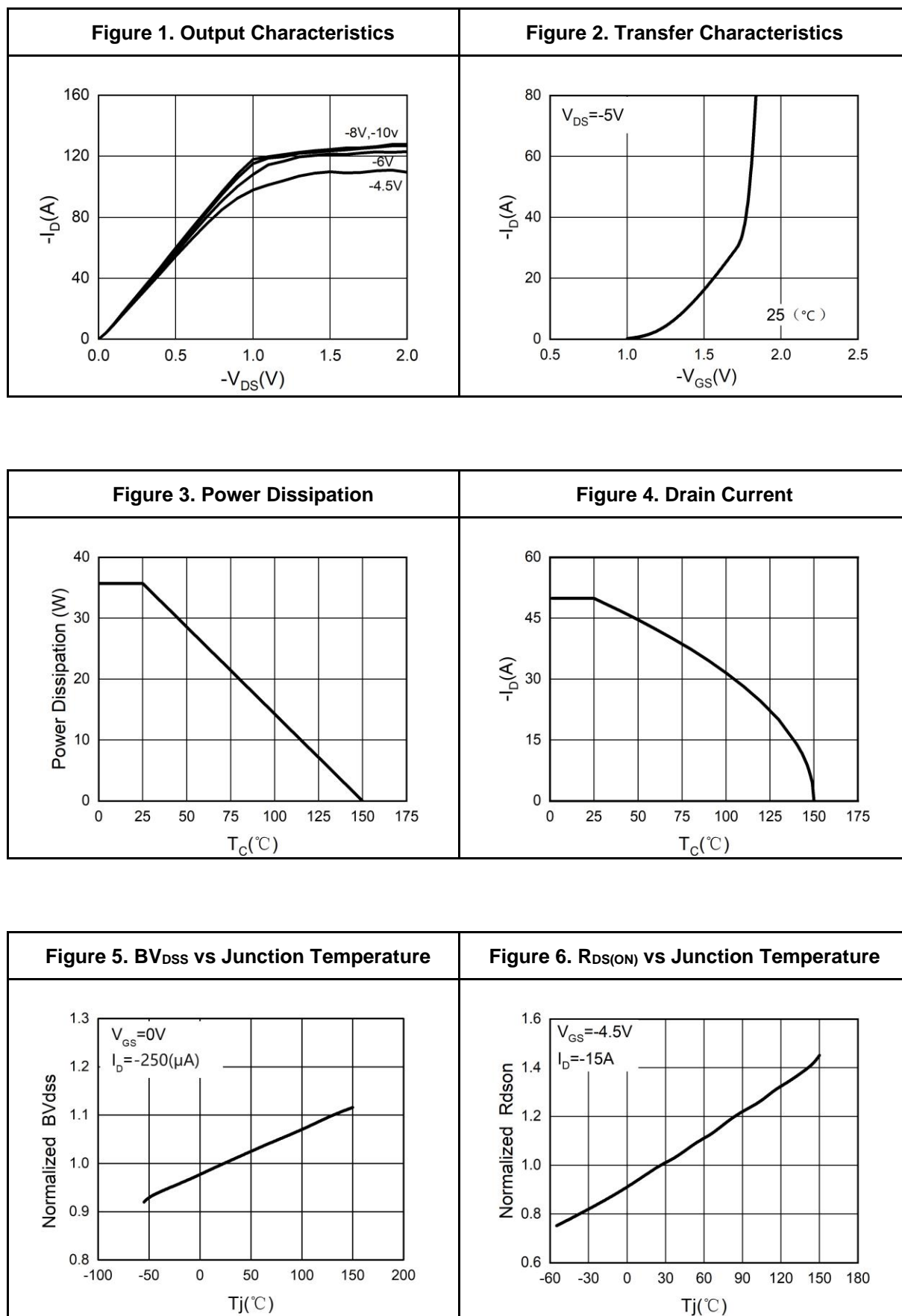
Notes 2.EAS condition: $T_J=25^{\circ}\text{C}, V_{DD}=-20V, V_G=-10V, R_g=25\Omega, L=0.5\text{mH}$.

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



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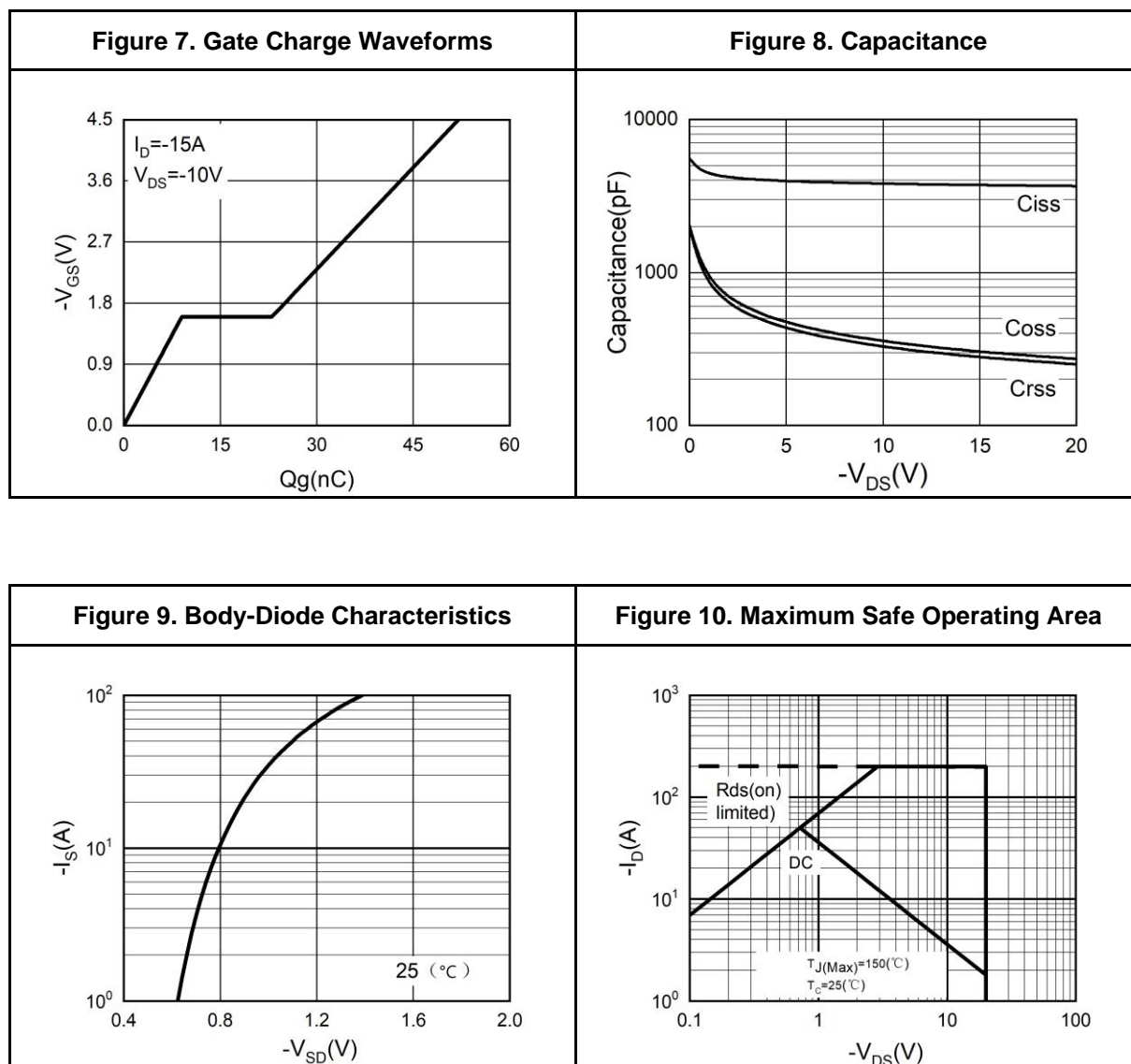
Typical Electrical And Thermal Characteristics (Curves)





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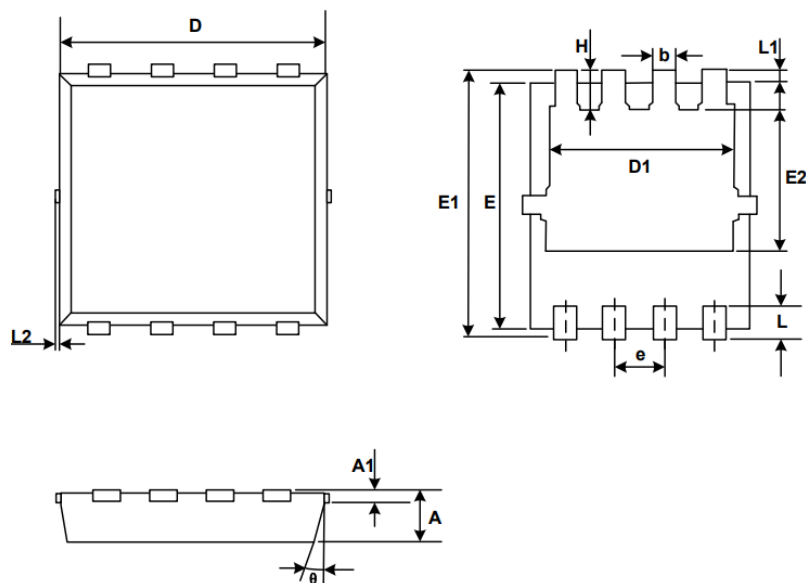




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PDFN3X3-8L Package Information

COMMON DIMENSIONS



SYMBOL	MM	
	MIN	MAX
A	0.65	0.90
A1	0.10	0.25
D	2.90	3.25
D1	2.25	2.69
E	2.90	3.20
E1	3.00	3.60
E2	1.35	2.20
b	0.20	0.40
e	0.65BSC	
L	0.15	0.50
L1	0.13BSC	
L2	0.00	0.20
H	0.15	0.65
θ	0°	14°



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